

TOSHIBA Bipolar Digital Integrated Circuit Silicon Monolithic

**TD62001APG,TD62001AFG,TD62002APG,TD62002AFG,
TD62003APG,TD62003AFG,TD62004APG,TD62004AFG**

7-channel Darlington Sink Driver

The TD62001APG/AFG Series are high-voltage, high-current darlington drivers comprised of seven NPN darlington pairs. All units feature integral clamp diodes for switching inductive loads.

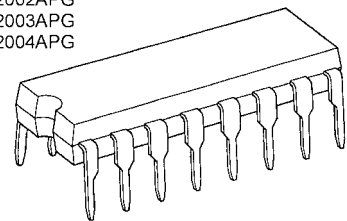
Applications include relay, hammer, lamp and display (LED) drivers.

Features

- Output current (single output): 500 mA (max)
- High sustaining voltage output: 50 V (min)
- Output clamp diodes
- Inputs compatible with various types of logic
- Package type
 - APG: DIP-16 pin (Pb free package)
 - AFG: SOP-16 pin (Pb free package)

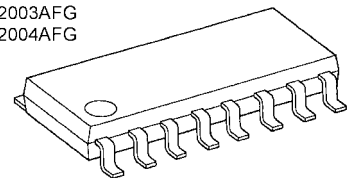
Type	Input base resistor	Designation
TD62001APG/AFG	External	General purpose
TD62002APG/AFG	10.5-k Ω + 7-V Zenner diode	14-V to 25-V PMOS
TD62003APG/AFG	2.7 k Ω	TTL, 5-V CMOS
TD62004APG/AFG	10.5 k Ω	6-V to 15-V PMOS, CMOS

TD62001APG
TD62002APG
TD62003APG
TD62004APG



DIP16-P-300-2.54A

TD62001AFG
TD62002AFG
TD62003AFG
TD62004AFG

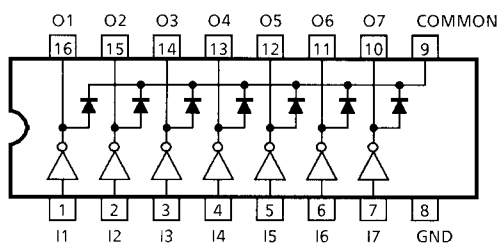


SOP16-P-225-1.27

Weight

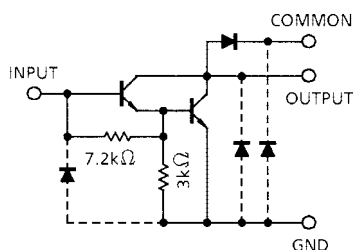
DIP16-P-300-2.54A : 1.11 g (Typ.)
SOP16-P-225-1.27 : 0.16 g (Typ.)

Pin Connection (top view)

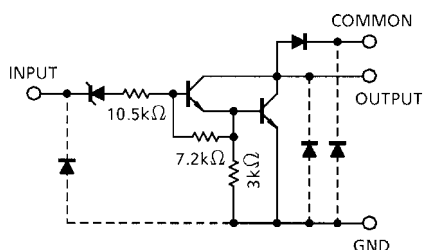


Schematics (each driver)

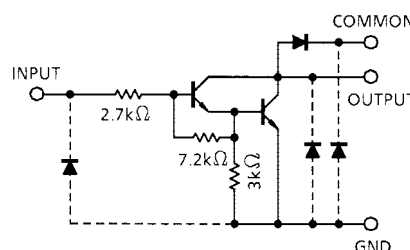
TD62001APG/AFG



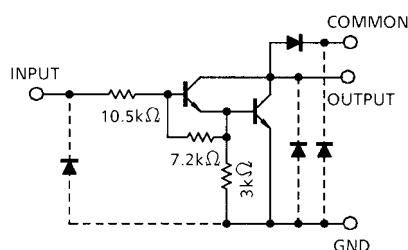
TD62002APG/AFG



TD62003PAPG/AFG



TD62004APG/AFG



Note: The input and output parasitic diodes cannot be used as clamp diodes.

Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Output sustaining voltage		V _{CE (SUS)}	−0.5 to 50	V
Output current		I _{OUT}	500	mA/ch
Input voltage		V _{IN} (Note 1)	−0.5 to 30	V
Input current		I _{IN} (Note 2)	25	mA
Clamp diode reverse voltage		V _R	50	V
Clamp diode forward current		I _F	500	mA
Power dissipation	APG	P _D	1.47	W
	AFG		0.625 (Note 3)	
Operating temperature		T _{opr}	−40 to 85	°C
Storage temperature		T _{stg}	−55 to 150	°C

Note 1: Except TD62001APG/AFG

Note 2: Only TD62001APG/AFG

Note 3: When mounted on a glass-epoxy PCB (30 mm × 30 mm × 1.6 mm, Cu area: 50%)

Recommended Operating Conditions (Ta = -40°C to 85°C)

Characteristics		Symbol	Condition		Min	Typ.	Max	Unit
Output sustaining voltage		V _{CE (SUS)}			0	—	50	V
Output current	APG	I _{OUT}	T _{pw} = 25 ms 7 circuits Ta = 85°C Tj = 120°C	Duty = 10%	0	—	370	mA/ch
				Duty = 50%	0	—	130	
	AFG			Duty = 10%	0	—	233	
				Duty = 50%	0	—	70	
Input voltage	Except TD62001APG/AFG	V _{IN}			0	—	24	V
Input voltage (output on)	TD62002	V _{IN (ON)}	I _{OUT} = 400 mA h _{FE} = 800		14.5	—	24	V
	TD62003				2.8	—	24	
	TD62004				6.2	—	24	
Input voltage (output off)	TD62001	V _{IN (OFF)}			0	—	0.6	V
	TD62002				0	—	7.4	
	TD62003				0	—	0.7	
	TD62004				0	—	1.0	
Input current	Only TD62001	I _{IN}			0	—	10	mA
Clamp diode reverse voltage		V _R			—	—	50	V
Clamp diode forward current		I _F			—	—	350	mA
Power dissipation	APG	P _D	Ta = 85°C		—	—	0.76	W
	AFG		Ta = 85°C (Note)		—	—	0.325	

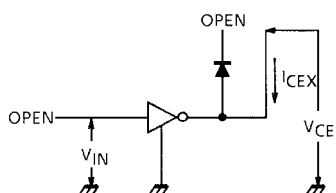
Note: When mounted on a glass-epoxy PCB (30 mm × 30 mm × 1.6 mm, Cu area: 50%)

Electrical Characteristics (Ta = 25°C unless otherwise noted)

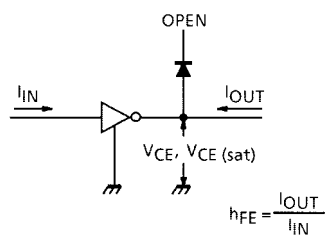
Characteristics		Symbol	Test Circuit	Test Condition		Min	Typ.	Max	Unit	
Ooutput leakage current		I _{CEX}	1	V _{CE} = 50 V, Ta = 25°C		—	—	50	μA	
				V _{CE} = 50 V, Ta = 85°C		—	—	100		
Collector–emitter saturation voltage		V _{CE (sat)}	2	I _{OUT} = 350 mA, I _{IN} = 500 μA		—	1.3	1.6	V	
				I _{OUT} = 200 mA, I _{IN} = 350 μA		—	1.1	1.3		
				I _{OUT} = 100 mA, I _{IN} = 250 μA		—	0.9	1.1		
DC current transfer ratio		h _{FE}	2	V _{CE} = 2 V, I _{OUT} = 350 mA		1000	—	—		
Input current (output on)	TD62002	I _{IN (ON)}	3	V _{IN} = 20 V, I _{OUT} = 350 mA		—	1.1	1.7	mA	
	V _{IN} = 2.4 V, I _{OUT} = 350 mA			—	0.4	0.7				
	V _{IN} = 9.5 V, I _{OUT} = 350 mA			—	0.8	1.2				
Input current (output off)		I _{IN (OFF)}	4	I _{OUT} = 500 μA, Ta = 85°C		50	65	—	μA	
Input voltage (output on)	TD62002	V _{IN (ON)}	5	V _{CE} = 2 V h _{FE} = 800	I _{OUT} = 350 mA	—	—	13.7	V	
					I _{OUT} = 200 mA	—	—	11.4		
	TD62003				I _{OUT} = 350 mA	—	—	2.6		
					I _{OUT} = 200 mA	—	—	2.0		
	TD62004				I _{OUT} = 350 mA	—	—	4.7		
					I _{OUT} = 200 mA	—	—	4.4		
Clamp diode reverse current		I _R	6	V _R = 50 V, Ta = 25°C		—	—	50	μA	
				V _R = 50 V, Ta = 85°C		—	—	100		
Clamp diode forward voltage		V _F	7	I _F = 350 mA		—	—	2.0	V	
Input capacitance		C _{IN}	—			—	15	—	pF	
Turn-on delay		t _{ON}	8	V _{OUT} = 50 V, R _L = 125 Ω C _L = 15 pF		—	0.1	—	μs	
Turn-off delay		t _{OFF}	8	V _{OUT} = 50 V, R _L = 125 Ω C _L = 15 pF		—	0.2	—		

Test Circuit

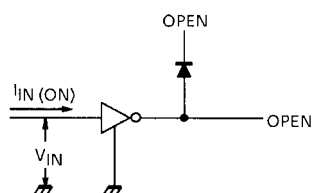
1. I_{CEX}



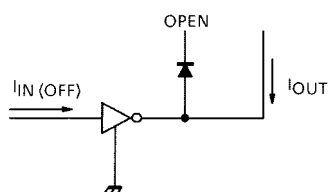
2. $V_{CE} (sat)$, h_{FE}



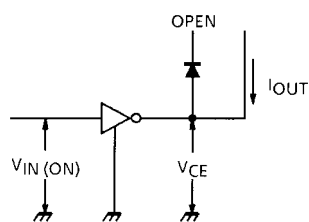
3. $I_{IN} (ON)$



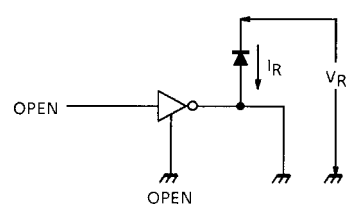
4. $I_{IN} (OFF)$



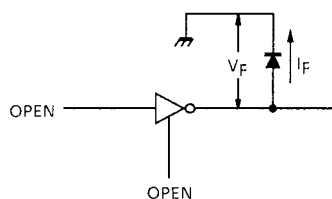
5. $V_{IN} (ON)$



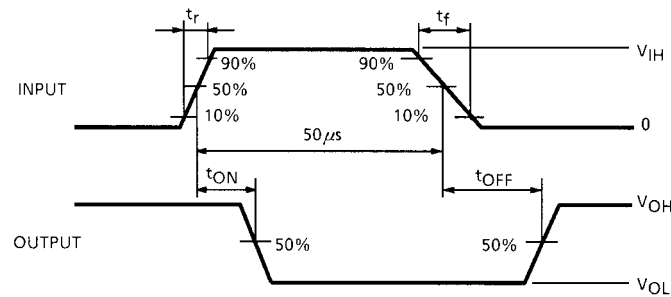
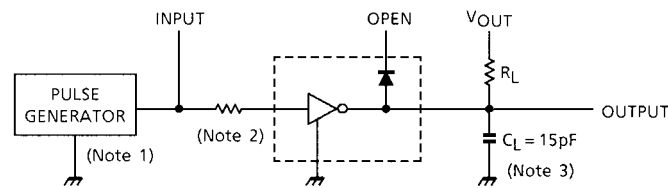
6. I_R



7. V_F



8. t_{ON} , t_{OFF}



- Note 1: Pulse width 50 μ s, duty cycle 10%
Output impedance 50 Ω , $t_r \leq 5$ ns, $t_f \leq 10$ ns
- Note 2: Input conditions are shown as following:

Input Condition

Type Number	R1	V_{IH}
TD62001APG/AFG	2.7 k Ω	3 V
TD62002APG/AFG	0	13 V
TD62003APG/AFG	0	3 V
TD62004APG/AFG	0	8 V

- Note 3: C_L includes probe and jig capacitance.

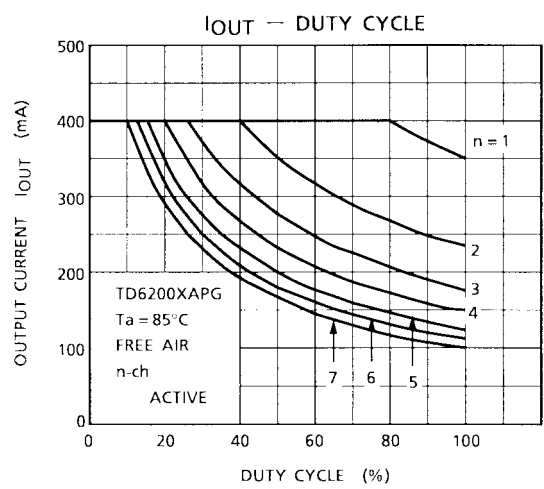
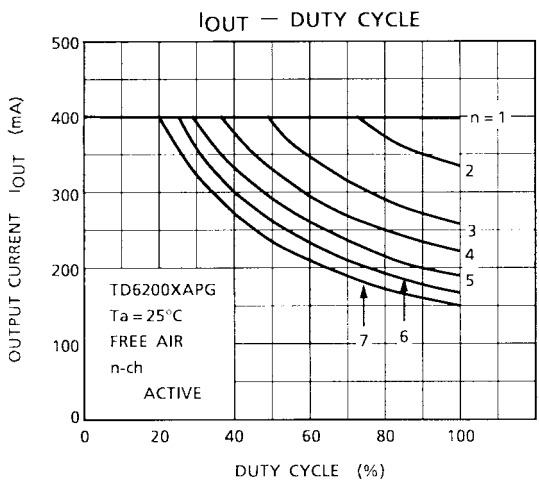
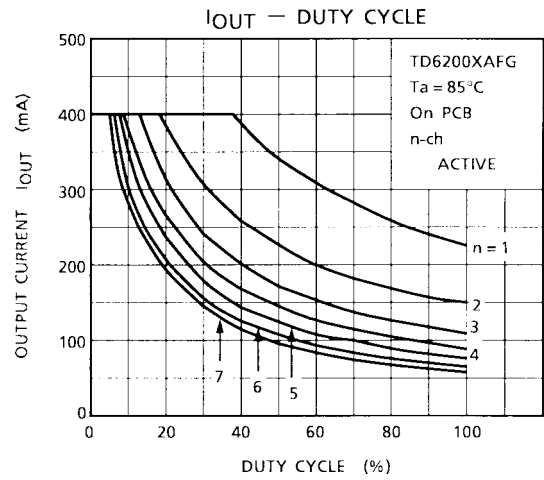
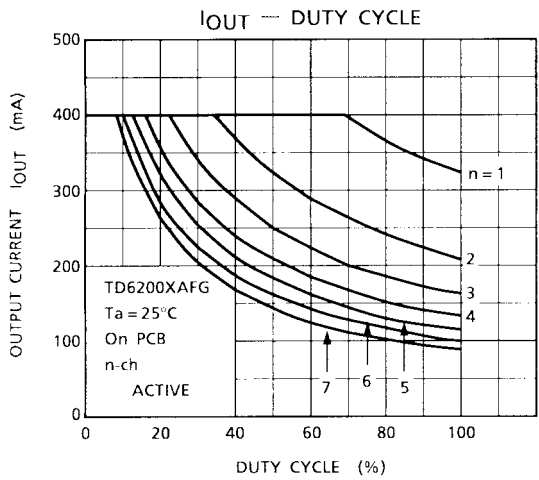
Precautions for Using

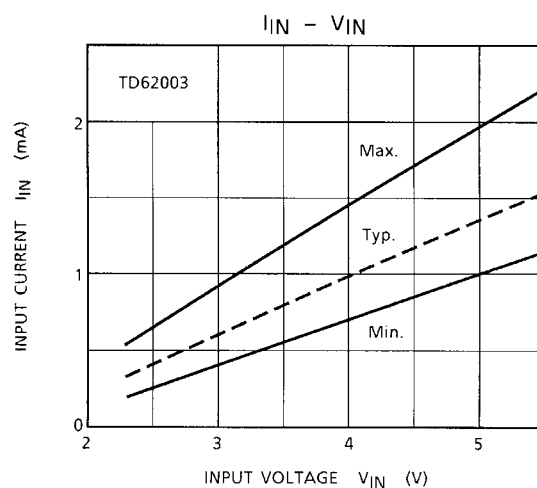
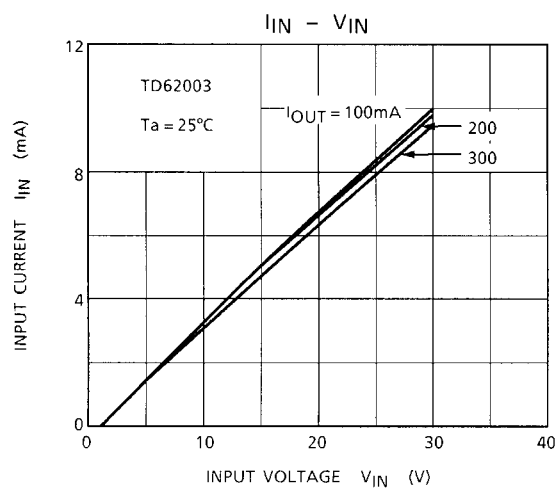
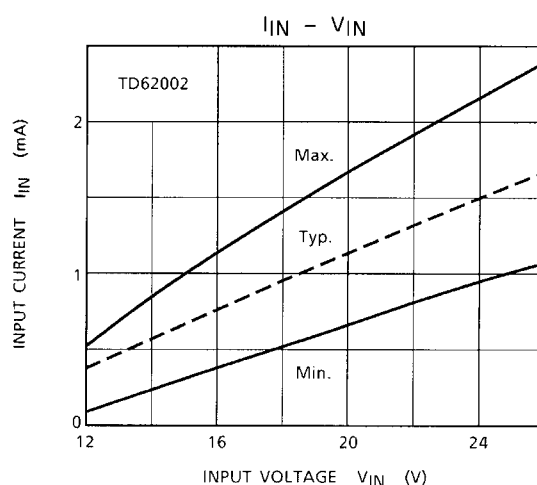
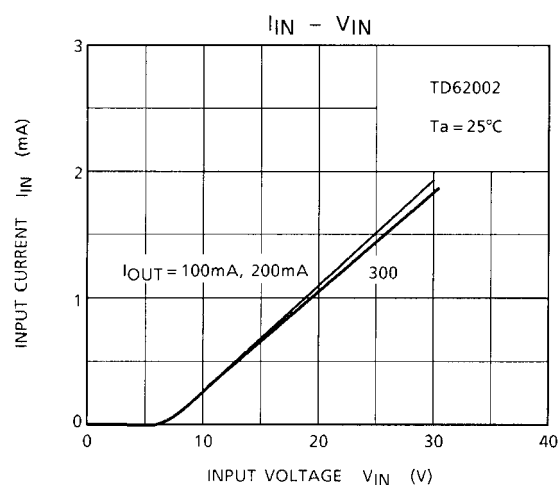
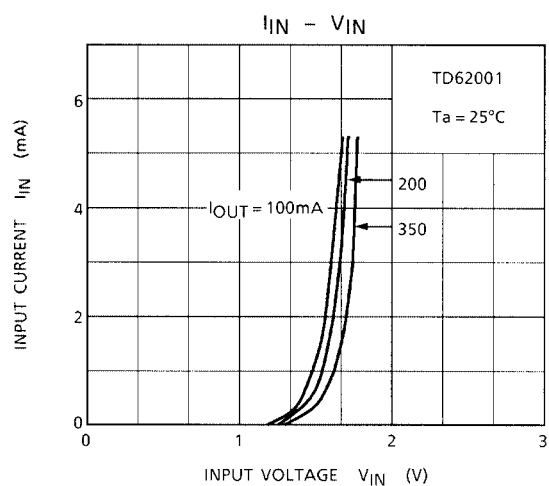
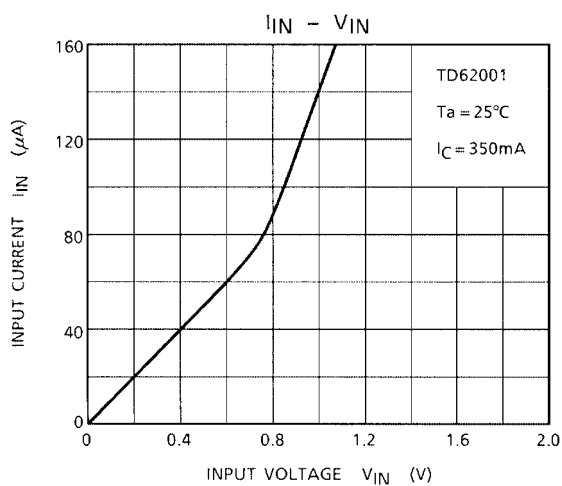
This IC does not include built-in protection circuits for excess current or overvoltage.

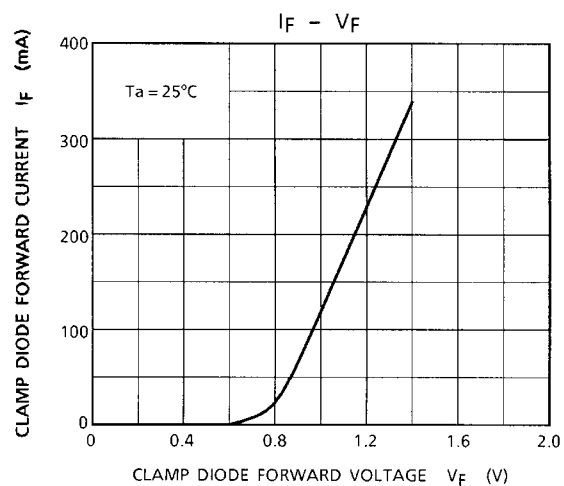
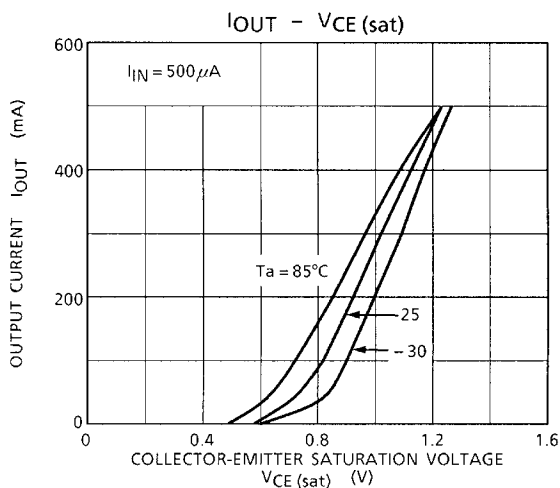
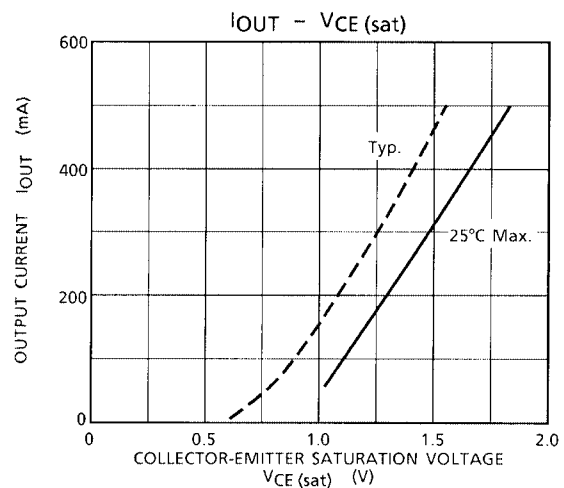
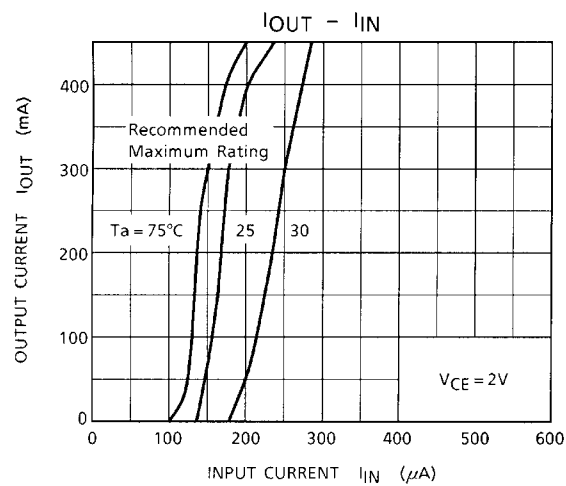
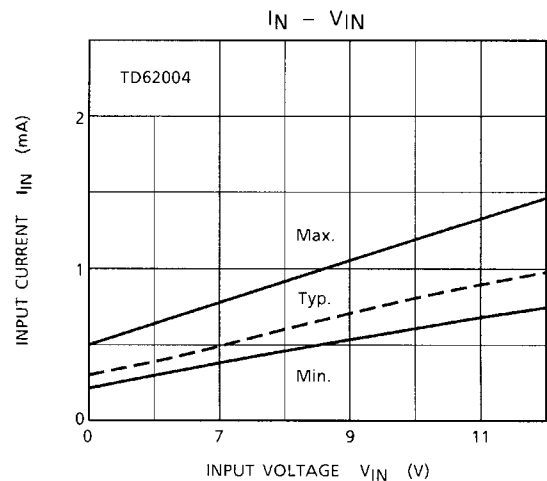
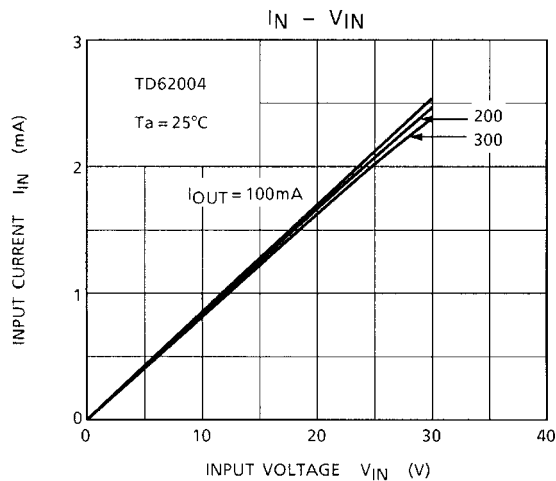
If this IC is subjected to excess current or overvoltage, it may be destroyed.

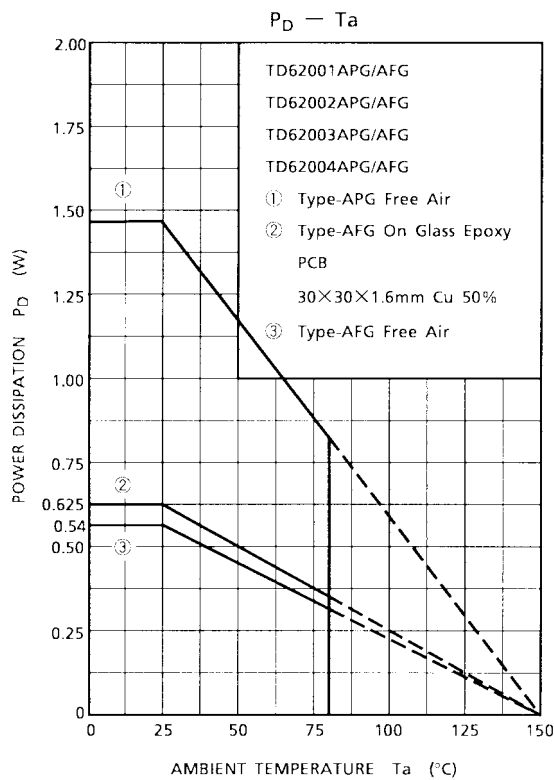
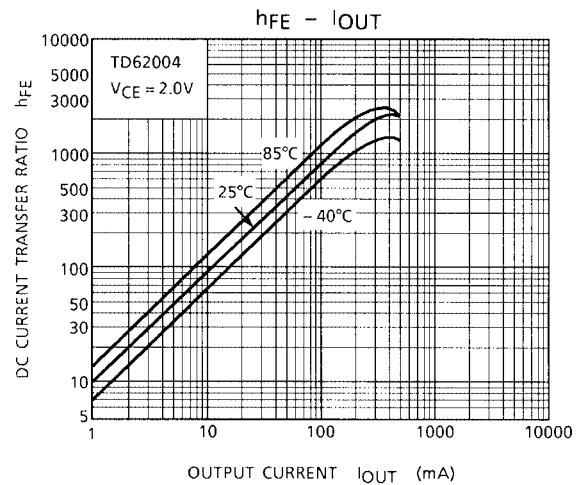
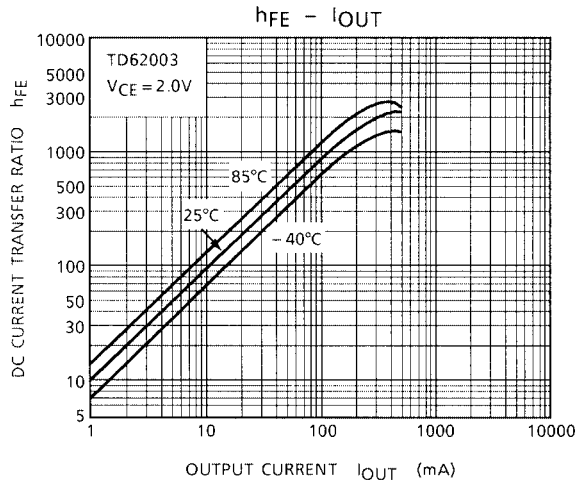
Hence, the utmost care must be taken when systems which incorporate this IC are designed.

Utmost care is necessary in the design of the output line, COMMON and GND line since IC may be destroyed due to short-circuit between outputs, air contamination fault, or fault by improper grounding.





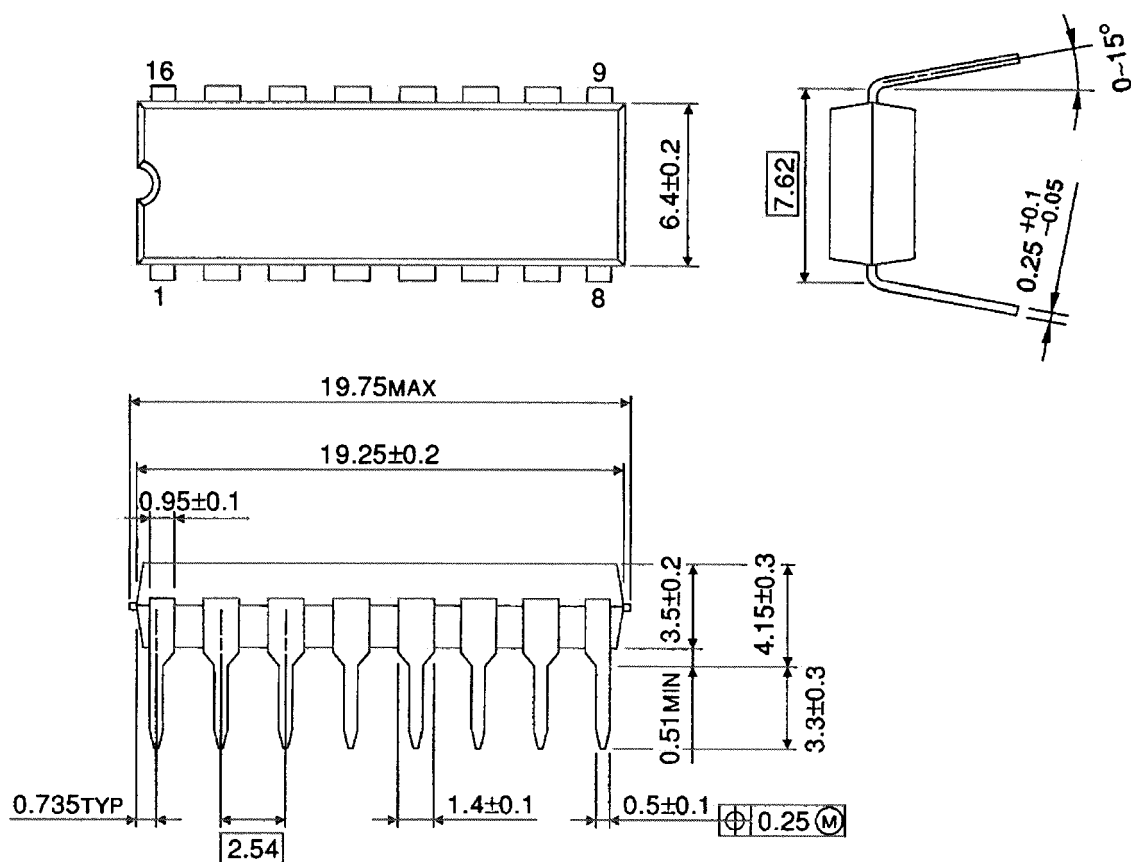




Package Dimensions

DIP16-P-300-2.54A

Unit : mm

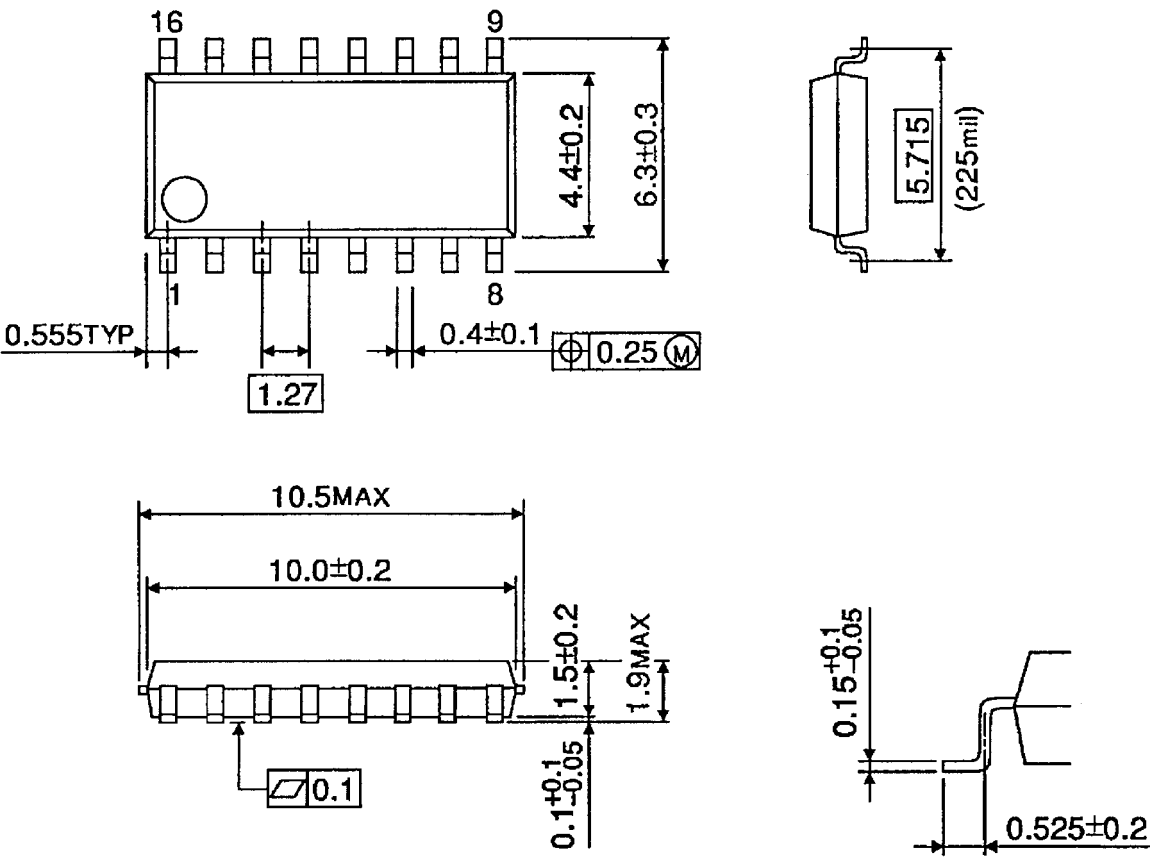


Weight: 1.11 g (Typ.)

Package Dimensions

SOP16-P-225-1.27

Unit : mm



Weight: 0.16 g (Typ.)

RESTRICTIONS ON PRODUCT USE

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